









PRODUCT DATASHEET



- ► PLCC2 SMD
- ➤ 3528 1.9t Series
- ► Warm White 3000K

N0W50S14





3528 1.9t Series





Release Date: 04 June 2022 Version: A1.1

FEATURES:

- Package: Top View PLCC2 White SMD Package
- Forward Current: 20mA Forward Voltage (typ.): 3.2V
- Luminous Intensity (typ.): 1700mcd@20mA
- Colour: Warm White
- Colour Temperature (CCT): 2800~3100K
- Viewing angle: 120°
- **Materials:**
 - Die: InGaN
 - Resin: Silicon (Yellow Diffused)
 - L/T Finish: Ag plated
- Operating Temperature: -40~+85°C
- Storage Temperature: -40~+100°C
- **Grouping parameters:**
 - Forward Voltage
 - **Luminous Intensity**
 - **CIE Chromaticity**
- Soldering methods: Reflow Soldering
- **Preconditioning:** MSL 2a according to J-STD020
- Packing: 8mm tape with max.2000/reel, ø180mm (7")

APPLICATIONS:

- Portable Lighting
- **Commercial Lighting**
- **Indoor Lighting**
- Backlight for LCD
- **General Lighting**



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	IF	30	mA
Pulse Forward Current @Duty 1/10, 0.1ms	IPF	100	mA
Reverse Voltage	V _R	5	V
Reverse Current @10V	I _R	10	μΑ
Junction Temperature	Tj	110	°C
Electrostatic Discharge (HBM)	ESD	1000	V
Operating Temperature	T_{OPR}	-40~+85	°C
Storage Temperature	T _{STG}	-40~+100	°C
Soldering Temperature	T _{SOL}	260	°C
Colour Rendering Index	CRI	95	

Electrical & Optical Characteristics (Ta=25°C)

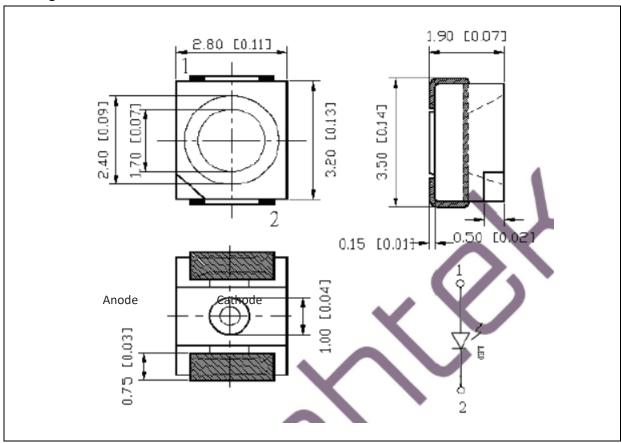
Darameter	Symbol	Values			Unit	Test	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
Forward Voltage	VF	2.8		3.6	V	I _F =20mA	
Luminous Intensity	lv	1450	1700	2250	mcd	I _F =20mA	
Chromaticity Coordinates	Х		0.4398			I⊧=20mA	
	Υ		0.4048				
Colour Temperature	ССТ	2800	2960	3100	К	I _F =20mA	
Viewing Angle	2θ _{1/2}		120		deg	I _F =20mA	

^{1.} Luminous Intensity (Φ_V) $\pm 10\%$, Forward Voltage (V_F) $\pm 0.1V$, Colour Coordinate: ± 0.005 , Viewing Angle($2\theta 1/2$) $\pm 5\%$, CRI ± 5



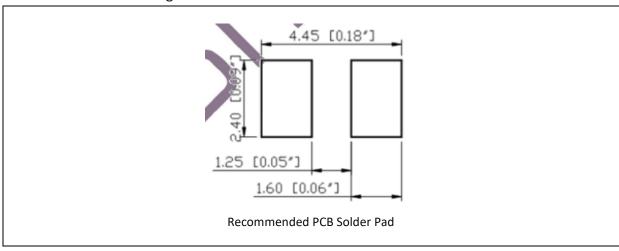
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.13mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 20mA):

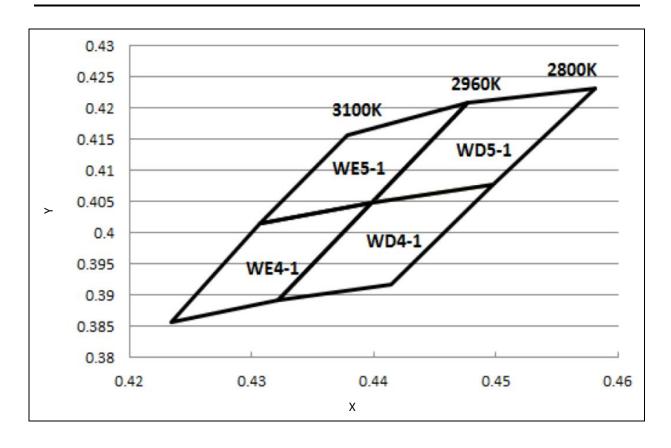
Code	Min.	Max.	Unit
В	2.8	2.9	
С	2.9	3.0	
D	3.0	3.1	
E	3.1	3.2	V
F	3.2	3.3	V
G	3.3	3.4	
Н	3.4	3.5	
I	3.5	3.6	

Luminous Intensity Classifications (I_F = 20mA):

Code	Min.	Max.	Unit
3	1450	1650	
4	1650	1850	mad
5	1850	2050	mcd
6	2050	2250	



CIE CHROMATICITY DIAGRAM:

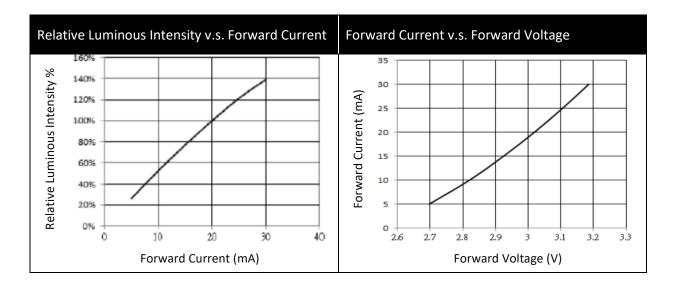


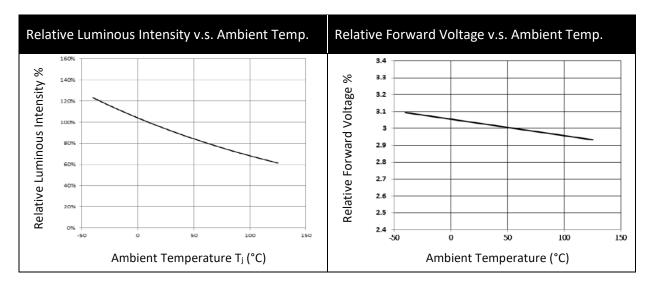
Chromaticity Coordinates Classifications (IF = 20mA):

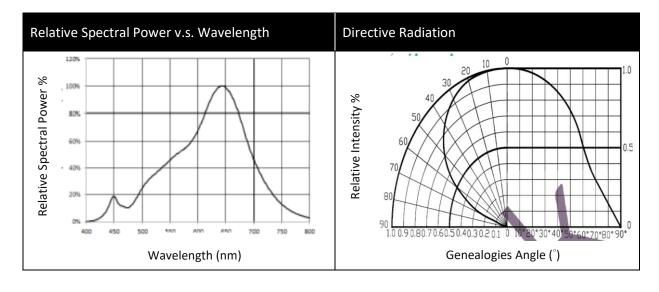
	1	1	2		3		4	
	Х	Υ	Х	Y	Х	Υ	Х	Υ
WE4-1	0.4234	0.3857	0.4322	0.3892	0.4398	0.4048	0.4307	0.4016
WE5-1	0.4307	0.4016	0.4398	0.4048	0.4477	0.4208	0.4379	0.4157
WD4-1	0.4322	0.3892	0.4414	0.3917	0.4498	0.4077	0.4398	0.4048
WD5-1	0.4398	0.4048	0.4498	0.4077	0.4581	0.4233	0.4477	0.4208



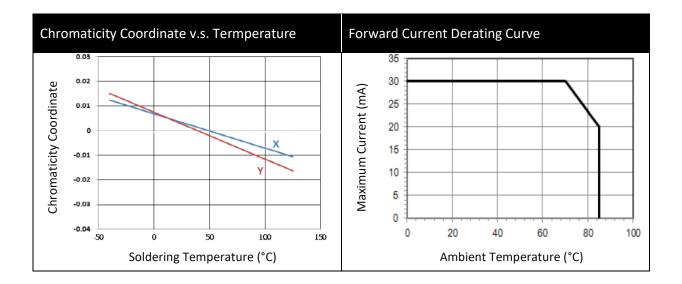
ELECTRO-OPTICAL CHARACTERISTICS:







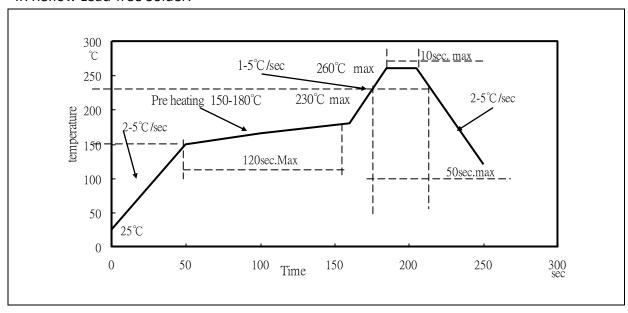






RECOMMENDED SOLDERING PROFILE:

IR Reflow Lead-free Solder:



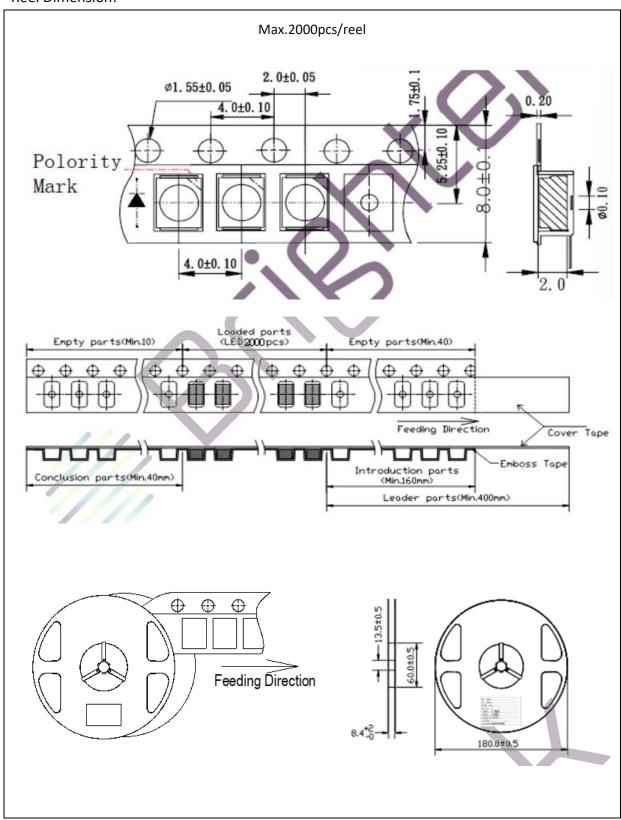
Note:

- 1. Recommended soldering temperature: 240°C. The maximum soldering temperature should be limited to 260°C.
- 2. Maxima reflow soldering: 3 times.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking.

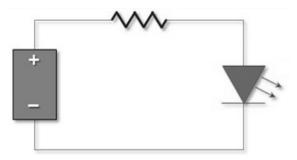
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 6hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	02/11/2019	Datasheet set-up.
A1.1	04/06/2022	New datasheet format.